

CLAIMS

What is claimed is:

1. A process comprising:
  - 5 a) depositing an organic semiconductor on a donor substrate;
  - b) laminating the organic semiconductor on the donor substrate with a receiver substrate; and
  - c) removing the donor substrate.
- 10 2. The process of Claim 1 where the receiver substrate is a flexible polymer.
3. An electronic device comprising an organic semiconductor laminated on a receiver substrate.
4. The electronic device of Claim 3 where the device is a transistor.
- 15 5. The electronic device of Claim 3 or 4 where the receiver substrate is a flexible polymer.